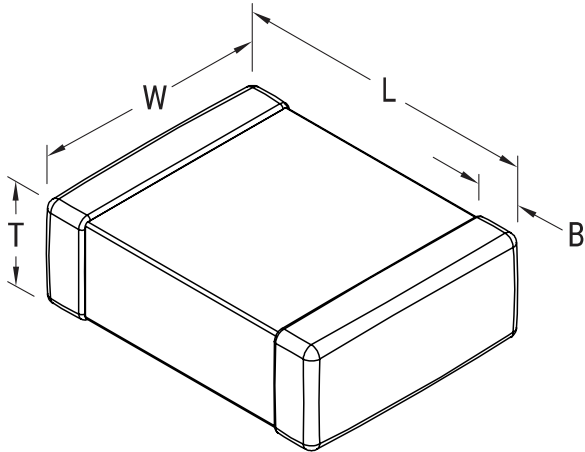




Click [here](#) for the 3D model.

General Information

Series	CQ
Style	SMD Chip
Description	SMD, MLCC, High Frequency
Features	High Frequency
RoHS	Yes
Termination	Tin
MSL	1

Dimensions

L	1.6mm +/-0.1mm
W	0.8mm +/-0.10mm
T	0.8mm +/-0.10mm
B	0.4mm +/-0.2mm
Case Code (EIA / mm)	0603 / 1608

Packaging Specifications

Packaging	T&R, 330mm, Paper Tape
Packaging Quantity	15000

Specifications

Capacitance	10 pF
Tolerance	5%
Voltage DC	50 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Dissipation Factor	0.1666667%
Insulation Resistance	10 GOhms

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